



# PNP Silicon Low-Power Transistor Qualified per MIL-PRF-19500/485

Qualified Levels: JAN, JANTX, JANTXV and JANS

## **DESCRIPTION**

This family of 2N5415S and 2N5416S epitaxial planar transistors are military qualified up to a JANS level for high-reliability applications. These devices are also available in the longer leaded TO-5 and low profile U4 and UA packaging.

Important: For the latest information, visit our website <a href="http://www.microsemi.com">http://www.microsemi.com</a>.

## **FEATURES**

- JEDEC registered 2N5415 through 2N5416 series
- JAN, JANTXV, and JANS qualifications are available per MIL-PRF-19500/485.
   (See part nomenclature for all available options.)
- · RoHS compliant commercial version

## **APPLICATIONS / BENEFITS**

- General purpose transistors for low power applications requiring high frequency switching.
- Low package profile.
- Military and other high-reliability applications.



# TO-205AD (TO-39) Package

## Also available in:

TO-5 package (long-leaded) 2N5415 – 2N5416

U4 package (surface mount) 2N5415U4 – 2N5416U4

UA package (surface mount) <u>2N5415UA − 2N5416UA</u>

## MAXIMUM RATINGS @ TA = +25 °C unless otherwise noted

Parameters / Test Conditions		2N5415S	2N5416S	Unit
Collector-Emitter Voltage	$V_{CEO}$	200	300	V
Collector-Base Voltage	V <sub>CBO</sub>	200 350		V
Emitter-Base Voltage	V <sub>EBO</sub>	6.0 6.0		V
Collector Current	Ic	1.0 1.0		Α
Operating & Storage Junction Temperature Range	$T_J, T_{stg}$	-65 to +200		°C
Thermal Resistance Junction-to-Ambient	$R_{\Theta JA}$	234		°C/W
Thermal Resistance Junction-to-Case	$R_{ heta JC}$	17.5		°C/W
Total Power Dissipation @ $T_A = +25  ^{\circ}C^{(1)}$ @ $T_C = +25  ^{\circ}C^{(2)}$	P <sub>T</sub>	0.75 10		W

Notes: 1. Derate linearly 4.29 mW/°C for T<sub>A</sub> > +25 °C.

2. Derate linearly 57.2 mW/°C for  $T_C > +25$  °C.

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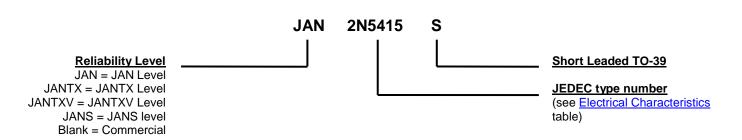
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## **MECHANICAL and PACKAGING**

- CASE: Hermetically sealed, kovar base, nickel cap
- TERMINALS: Gold plated kovar and solder dip (Sn63/Pb37) on JAN, JANTX, and JANTXV versions. NOTE: Solder dipped versions are not RoHS compliant.
- MARKING: Part number, date code, manufacturer's ID and serial number
- POLARITY: PNP
- WEIGHT: Approximately 1.064 grams
- See <u>Package Dimensions</u> on last page.

## **PART NOMENCLATURE**



SYMBOLS & DEFINITIONS			
Symbol	Definition		
$C_obo$	Common-base open-circuit output capacitance		
I <sub>CEO</sub>	Collector cutoff current, base open		
I <sub>CEX</sub>	Collector cutoff current, circuit between base and emitter		
I <sub>EBO</sub>	Emitter cutoff current, collector open		
$h_{FE}$	Common-emitter static forward current transfer ratio		
$V_{CEO}$	Collector-emitter voltage, base open		
$V_{CBO}$	Collector-emitter voltage, emitter open		
$V_{EBO}$	Emitter-base voltage, collector open		



## **ELECTRICAL CHARACTERISTICS** @ T<sub>A</sub> = +25 °C, unless otherwise noted

## **OFF CHARACTERISTICS**

Parameters / Test Conditions		Symbol	Min.	Max.	Unit
Collector-Emitter Breakdown Voltage					
$I_C = 50 \text{ mA}, I_B = 5 \text{ mA},$	2N5415S	$V_{(BR)CEO}$	200		V
L = 25  mH; $f = 30 - 60  Hz$	2N5416S		300		
Emitter-Base Cutoff Current		1		20	
$V_{EB} = 6.0 \text{ V}$		I <sub>EBO</sub>		20	μA
Collector-Emitter Cutoff Current					
$V_{CE} = 200 \text{ V}, V_{BE} = 1.5 \text{ V}$	2N5415S	I <sub>CEX</sub>		50	μΑ
$V_{CE} = 300 \text{ V}, V_{BE} = 1.5 \text{ V}$	2N5416S				
Collector-Emitter Cutoff Current					
V <sub>CE</sub> = 150 V	2N5415S	I <sub>CEO1</sub>		50	μΑ
$V_{CE} = 250 \text{ V}$	2N5416S				
Collector-Emitter Cutoff Current					
V <sub>CE</sub> = 200 V	2N5415S	I <sub>CEO2</sub>		1	mΑ
$V_{CE} = 300 \text{ V}$	2N5416S				
Collector-Base Cutoff Current					
V <sub>CB</sub> = 175 V	2N5415S	I <sub>CBO1</sub>		50	μΑ
$V_{CB} = 280 \text{ V}$	2N5416S				
$V_{CB} = 200 \text{ V}$	2N5415S	I <sub>CBO2</sub>		500	μА
$V_{CB} = 350 \text{ V}$	2N5416S	ICBO2		300	μΛ
$V_{CB} = 175 \text{ V}, T_A = +150  {}^{\circ}\text{C}$	2N5415S	Longo		1	mΑ
$V_{CB} = 280 \text{ V}, T_A = +150  {}^{\circ}\text{C}$	2N5416S	I <sub>CBO3</sub>		ı	111/-

## **ON CHARACTERISTICS**

Parameters / Test Conditions	Symbol	Min.	Max.	Unit
Forward-Current Transfer Ratio $I_C = 50$ mA, $V_{CE} = 10$ V $I_C = 1$ mA, $V_{CE} = 10$ V $I_C = 50$ mA, $V_{CE} = 10$ V, $T_A = +150$ °C	h <sub>FE</sub>	30 15 15	120	
Collector-Emitter Saturation Voltage I <sub>C</sub> = 50 mA, I <sub>B</sub> = 5 mA	V <sub>CE(sat)</sub>		2.0	V
Base-Emitter Voltage Non-Saturation $I_C = 50 \text{ mA}, V_{CE} = 10 \text{ V}$	V <sub>BE</sub>		1.5	V

## **DYNAMIC CHARACTERISTICS**

Parameters / Test Conditions	Symbol	Min.	Max.	Unit
Magnitude of Common Emitter Small-Signal Short-Circuit Forward Current Transfer Ratio $I_C = 10$ mA, $V_{CE} = 10$ V, $f = 5$ MHz	h <sub>fe</sub>	3	15	
Small-signal short Circuit Forward-Current Transfer Ratio I <sub>C</sub> = 5 mA, V <sub>CE</sub> = 10 V, f ≤ 1 kHz	h <sub>fe</sub>	25		
Output Capacitance $V_{CB} = 10 \text{ V}, I_E = 0, 100 \text{ kHz} \le f \le 1 \text{ MHz}$	C <sub>obo</sub>		15	pF



## ELECTRICAL CHARACTERISTICS @ T<sub>A</sub> = +25 °C unless otherwise noted. (continued)

## **SWITCHING CHARACTERISTICS**

Parameters / Test Conditions	Symbol	Min.	Max.	Unit
Turn-On Time $V_{CC} = 200 \text{ V}, I_C = 50 \text{ mA}, I_{B1} = 5 \text{ mA}$	t <sub>on</sub>		1	μs
Turn-Off Time $V_{CC} = 200 \text{ V}, I_C = 50 \text{ mA}, I_{B1} = I_{B2} = 5 \text{ mA}$	t <sub>off</sub>		10	μs

## SAFE OPERATING AREA (See SOA graph below and MIL-STD-750, method 3053)

DC Tests

 $T_C$  = +25 °C,  $t_P$  = 0.4 s, 1 Cycle

Test 1

 $V_{CE} = 10 \text{ V}, I_{C} = 1 \text{ A}$ 

Test 2

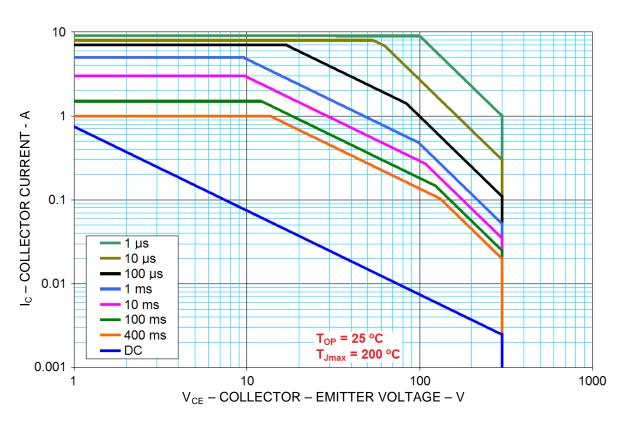
 $V_{CE} = 100 \text{ V}, I_{C} = 100 \text{ mA}$ 

Test 3

 $V_{CE} = 200 \text{ V}, I_{C} = 24 \text{ mA } (2N5415 \text{S only})$ 

Test 4

 $V_{CE} = 300 \text{ V}, I_{C} = 10 \text{ mA} (2N5416S \text{ only})$ 



Maximum Safe Operating Area (T<sub>J</sub> = 200 °C)



## **GRAPHS**

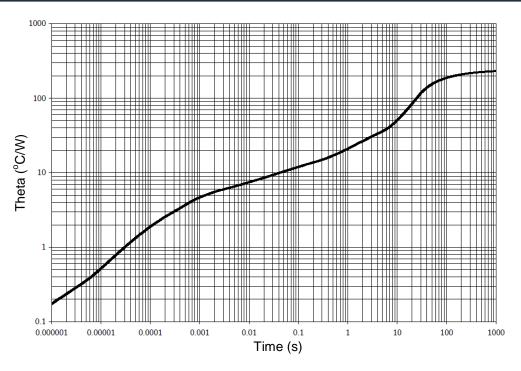


FIGURE 1
Thermal impedance graph (R<sub>OJA</sub>)

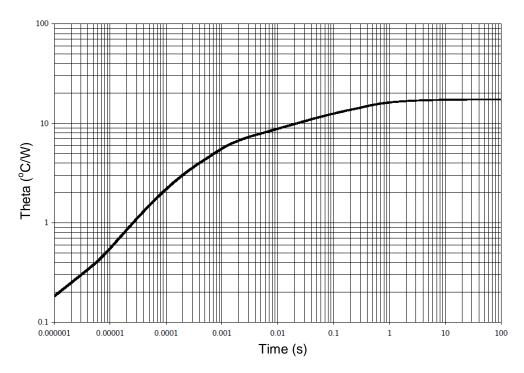
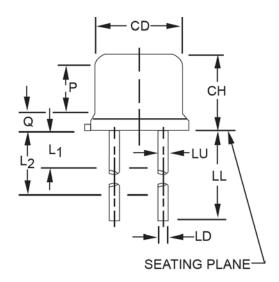


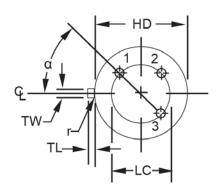
FIGURE 2
Thermal impedance graph (R<sub>OJA</sub>)

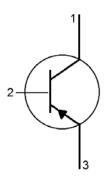


## **PACKAGE DIMENSIONS**



Dimensions						
Symbol	In	ch	Millimeters		Notes	
	Min	Max	Min	Max		
CD	0.305	0.335	7.75	8.51		
CH	0.240	0.260	6.10	6.60		
HD	0.335	0.370	8.51	9.40		
LC	0.20	0 TP	5.08	3 TP	6	
LD	0.016	0.021	0.41	0.53	7, 8	
LL	0.500	0.750	12.70	19.05	7, 8	
LU	0.016	0.019	0.41	0.48	7, 8	
L <sub>1</sub>	-	0.050	-	1.27	7, 8	
L <sub>2</sub>	0.250	-	6.35	-	7, 8	
Q	-	0.050	-	1.27	5	
TL	0.029	0.045	0.74	1.14	4	
TW	0.028	0.034	0.71	0.86	3	
r	-	0.010	-	0.25	10	
α	45°	TP	45° TP		6	
Р	0.100	-	2.54	-		





## **NOTES:**

- 1. Dimensions are in inches.
- 2. Millimeters are given for information only.
- 3. Beyond r (radius) maximum, TW shall be held for a minimum length of 0.011 (0.28 mm).
- 4. Dimension TL measured from maximum HD.
- 5. Body contour optional within zone defined by HD, CD, and Q.
- Leads at gauge plane 0.054 +0.001 -0.000 inch (1.37 +0.03 -0.00 mm) below seating plane shall be within 0.007 inch (0.18 mm) radius of true position (TP) at maximum material condition (MMC) relative to tab at MMC. This device may be measured by direct methods.
- 7. Dimension LU applies between L1 and L2. Dimension LD applies between L2 and minimum. Diameter is uncontrolled in L1 and beyond LL minimum.
- 8. All three leads.
- 9. The collector shall be internally connected to the case.
- 10. Dimension r (radius) applies to both inside corners of tab.
- 11. In accordance with ASME Y14.5M, diameters are equivalent to  $\Phi x$  symbology.
- 12. Lead 1 = emitter, lead 2 = base, lead 3 = collector.